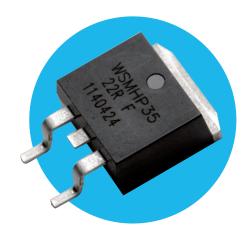
# **Resistors**

# Surface Mount High Power Resistors



#### **WSMHP Series**

- TO-263 surface mount package
- Very low thermal resistance
- Non-inductive, 20, 25 and 35 watt high power resistors
- Low profile package for high density PCB installation
- Suitable for board mounting with either solder or clip
- AEC-Q200 qualified





All parts are Pb-free and comply with EU Directive 2011/65/EU (RoHS2)

### **Electrical Data**

		WSMHP20	WSMHP25	WSMHP35	Conditions
Power rating	watts	20	25	35	Heatsink with 25°C flange temperature
Power rating	watts		2.5		Without heatsink
Thermal resistance	°C/W		3.3		Resistor hotspot to flange
Limiting element voltage	volts		500		dc or ac rms
Resistance range	ohms		0R5 – 100K		
Dielectric strength	volts		2000		dc for 60s
Working temperature range	°C		-55 to 175		
Insulation resistance	ohms		>10G		Between terminals and tab
Tolerances	%	≤11	R0: ±5 >1R0: ±1, ±	:5	
TCR	ppm/°C	≤3R0: ±300	>3R0-10R: ±100	>10R: ±50	25 to 105°C
Standard values			E24 preferred		

## **Physical Data**

Dim	nensions (mm) & Weight (g)	
Α	10.1 ±0.3	
В	10.1 ±0.3	
С	4.6 ±0.2	
D	5.0 ±1	- C
E	1.27 ±0.3	-   - M   -   - M   1   1   1   1   1   1   1   1   1
F	2.54 ±0.5	
G	3.2 ±0.2	
Н	0.43 ±0.07	
J	0.88 ±0.12	
K	1.32 ±0.15	
L	5.08 ±0.1	
M	1.35 ±0.1	
0	1.5 ±0.5	
P	2.54 ±0.1	
P1	0 to 3°	P - 10° 10°
P2	0 to 3°	
Q	6.9 ±0.3	P2
R	0 to 0.254	
Т	6.0 ±1	
Wt	1.5 nom.	



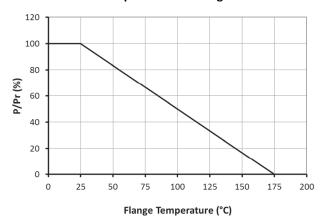




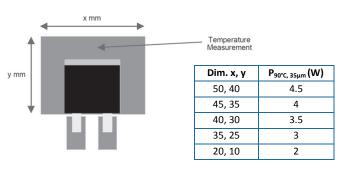
### **Performance Data**

Test		Performance
Load at Rated Power: 2000hrs at rated power	±∆R%	1
Short Term Overload: 2 x rated power with applied voltage not to exceed 1.5 x maximum continuous operating voltage for 5 seconds	±∆R%	0.3
High Temperature Exposure: MIL-STD-202 method 108, at 175°C for 1000hrs, no load	±∆R%	0.25
Temperature Cycling: JESD22 method JA-104,-55°C/175°C, 1000cycles	±∆R%	0.3
Biased Humidity: MIL-STD-202 method 103, 1000hrs 85°C/85% RH, 10% of operating power	±∆R%	0.5
Mechanical Shock: MIL-STD-202 method 213	±∆R%	0.5
Vibration: MIL-STD-202 method 204, peak acceleration 5g for 20min, 12 cycles each of 3 orientations, 10-2000Hz	±∆R%	0.2
Resistance to Soldering Heat: JIS-C-5201-1 4.18 IEC 60115-1 4.18, 260±5°C for 10 seconds	±∆R%	0.5
HBM ESD: AEC-Q200-002, human body 25kV (AD)	±∆R%	1
<b>Solderability:</b> J-STD-002, 240±5°C for 3 seconds		≥90% coverage
<b>Moisture Resistance:</b> MIL-STD-202 method 106, 10 cycles, 24hours $\pm \Delta R\%$		0.5
<b>Bending Strength:</b> AEC-Q200-005, Bending 2mm for 60 seconds $\pm \Delta R\%$		0.25
Terminal Strength: AEC-Q200-006, 1.8Kg for 60 seconds	±ΔR%	0.2

#### **Temperature Derating**

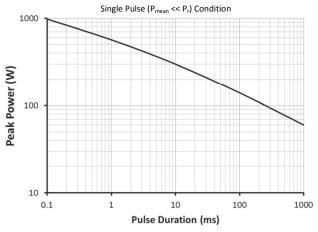


### **Typical Thermal Performance on FR4 Pad Heatsink**



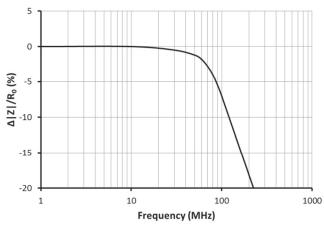
Characterisation carried out using 35  $\mu m$  PCB copper pad weights, with temperature of 90  $^{\circ} C$  used as a maximum reference on the PCB.  $P_{90^{\circ}\text{C},\,35\mu\text{m}}$  (W) is power when the measurement point reaches  $90^{\circ}\text{C}.$ 

#### **Pulse Performance**



Pulse performance for durations  $\geq 1s$  is dependent on mounting conditions. The short term overload power limit is 2 x power rating for 5s.

### **Typical High Frequency Performance**



 $\label{thm:continuous} \textbf{Typical high frequency characteristics for WSMHP35-220R. Self resonant frequency is \textbf{1GHz}.}$ 

### **Resistors**

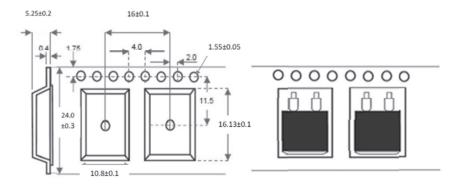
**Surface Mount High Power Resistors** 

**WSMHP Series** 



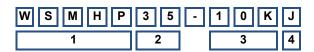
# **Packing**

WSMHP components are packed on 330mm diameter reels, with 100mm inner diameter, in tape of width 24mm and with a quantity of 500 pieces per reel. The dimensions of the tape and orientation of the component are as shown below.



# **Ordering Procedure**

Example: WSMHP35-10KJ (WSMHP35 at 10 kilohms ±5%, Pb-free)



1	2	3	4	
Type	Rating	Value	Tolerance	Packing
WSMHP	20	3 / 4 characters	F = ±1%	Plastic tape
	25	R = ohms	J = ±5%	500/reel
	35	K = kilohms		